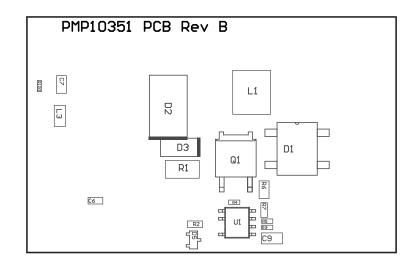


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM TOP SIDE | BOARD #: PMP10351 | REV: B | SVN REV | : Not In VersionControl |
|----------------------------------|--------------------|--------------|---------|-------------------------|
| IGNORE -> Top Overlay | | | | |
| PLOT NAME = Top Assembly Drawing | GENERATED : 9/15/2 | 2014 7:00:29 | AM | TEXAS INSTRUMENTS |



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

| PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP10351 | REV: B | SVN REV | : Not In VersionControl |
|-------------------------------------|-------------------------|--------------|---------|-------------------------|
| | Bottom Overlay <- ANNAI | | | |
| PLOT NAME = Bottom Assembly Drawing | GENERATED : 9/15/2 | 2014 7:00:30 | AM | TEXAS INSTRUMENTS |

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